



P.C.B TERMINAL POSITION

JF-00154

No	Description	Material	Qty	Plating	Specifications	PJ-008-H
1	Housing	PA46+30%Flder	1	94V-0	Rating: DC 12V 1A	TITLE: PHONE JACK
2	Spring	t0.2 Cu-Ti Alloy	4	Ag-Plating	Contact Resistance: 30m ohm max	UNLESS OTHERWISE SPECIFIED TOLERANCE ±0.1 ANGLE TOL ±30"
3					Insulation Resistance: 100M ohm at 500V	
4					Dielectnic Strength: AC 500V for 1 Minute	UNIT: mm SCALE: NA
5					Insertion & Extraction Force: 0.6-2.0kgf	DRAWN: xing
6					Life: 5.000 Cycles	DATE: 2004-08-19
					Taping: 1.000 Pcs	CHECKED:
XYFW(www.cnxyfw.com)						DATE:
						APPROVED:
						DATE: